



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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General Information

Part Number:	76650-0130
Manufacturer:	Molex / Waldom
Title:	Plateau HS Mezz Connector Kit
Description:	High Speed Mezzanine Gold Plug and Receptacle
Product Family:	Plateau HS Mezz™
Certificates:	(Molex Parts within this kit) - UL and CSA
Country of Origin:	Kit assembled in U.S.A.

Specifications

Design

Configuration:	Board-to-Board
Pitch:	1.20mm (.047")
Connector Type:	Receptacle and Plug

Mounting

Orientation:	Vertical
Circuit Sizes:	12, 24 and 48
Current Rating:	1.5 Amps
Voltage:	30 Volts

Product Highlights

Utilizes proprietary Plateau Technology™ (plated gold housing) to provide a high-speed high-density mezzanine connector system for differential and single-ended signal applications. The gold-plated plastic shields each differential pair from neighboring pairs, lowering crosstalk and improving signal clarity. Different stack heights and circuit sizes provide flexibility in design and grounding the conductive housing eliminates the need for individual ground pin designations within the connector.

Features and Benefits

- Advanced gold-plated housings with integrated shielding system
- Two points of contact on each signal
- Multiple stack heights from 10 to 25mm (.394 to .984")
- Available in 6, 12, 24, and 36 differential pair sizes (12, 24, 48 and 72 contacts)

Applications

- Switches and Hubs
- Routers
- Servers and Blade Servers
- Workstations
- Storage Devices

[For additional Molex / Waldom Design and Solution kits please go to www.molexkits.com](http://www.molexkits.com)

Bill of Materials for Part No. 76650-0130

Molex Part No.	Country of Origin	Description	Quantity in Kit
75005-0104	USA	1.20mm (.047") Pitch Plateau HS Mezz™ Receptacle, 48 Circuits	1
75003-0110	USA	1.20mm (.047") Pitch Plateau HS Mezz™ Plug, 48 Circuits, 13.25mm (.522") Unmated Height	1
75005-0006	USA	1.20mm (.047") Pitch Plateau HS Mezz™ Receptacle, 24 Circuits	1
75003-0010	USA	1.20mm (.047") Pitch Plateau HS Mezz™ Plug, 24 Circuits, 13.25mm (.522") Unmated Height	1
75005-0306	USA	1.20mm (.047") Pitch Plateau HS Mezz™ Receptacle, 12 Circuits	1
75003-0310	USA	1.20mm (.047") Pitch Plateau HS Mezz™ Plug, 12 Circuits, 13.25mm (.522") Unmated Height	1

No Recommended Molex Tool for Part Number 76650-0130